

CRYSTAL SPECIFICATION

TKD P/N : <u>CS16M008192NF1</u>

Product Description : 49SMD-8.192-16-30

Issue Date : ______ 2019.04.08

CUSTOMER'S APPROVAL

(PLEASE RETURN A COPY WITH APPOVAL

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REV.	Description of Revision History	Date	Designer	Checked By
	New revision	2019-04-08	Sutingting	Yexiuzhong



CRYSTAL SPECIFICATION

Description: Quartz Crystal
 Nominal Frequency: 8.192000MHz
 Oscillation Mode: Fundamental

4. Cutting Mode: AT cut

5. Measurement Instrument: S&A 250B(Measured FL)

6. Electrical Characteristics:[1]Operation Conditions:

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Operating Temperature Range	Topt	-40		85	$^{\circ}$	
Storage Temperature Range	Tstg	-40		90	\mathbb{C}	
Load Capacitance	CL		16		pF	
Drive Level	DL	0.1		100	uW	

[2]Frequency Stability:

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition	
Tolerance	dF/Fo	-30		30	ppm	Refer to Center Frequency@25±3°	
Stability Over Temperature	dF/F25	-30		30	ppm	Refer to Operating Temperature @-40~+85℃	
Aging	dF/F25	-5		5	ppm	Per Year	

dF/Fo:Frequency Deviation Refer to Center Frequency dF/F25:Frequency Deviation Refer to 25℃ Frequency

[3]Electrical Performance:

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Equivalent Series Resistance	ESR			60	Ω	@Series
Shunt Capacitance	C0			7	pF	
Insulation Resistance	IR	500			ΜΩ	@DC 100 Volt

7. Marking:Laser

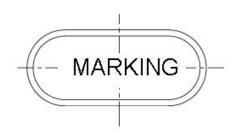
TKD:Company Logo

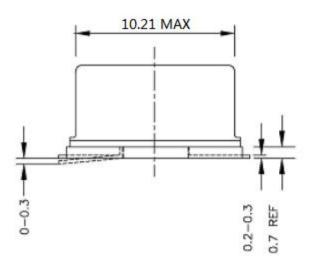
8.192:Nominal Frequency

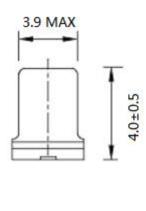
TKD8.192

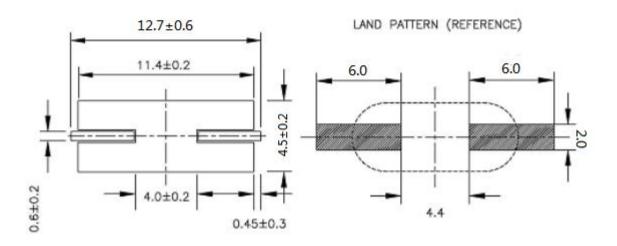


8. Outline drawing (unit: mm)











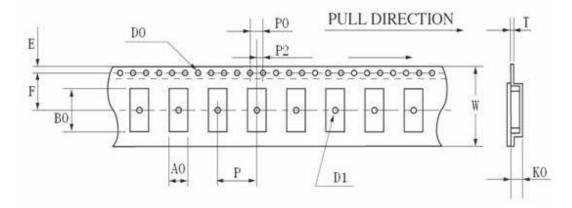
9. Reliability	y Specificati	ion			
Test Item			ondition of test	Performance	
Test item			Mailion or lest	Requirements	
Tensile Strength	The unit's l	ead wire should withstand	a tensile force applied to the	There should be no	
Termination			raw-out axis of up to 1000g		
	-	as is for 10±2s		the unit	
Solder ability		is immersed in a 235±5°	°C solder bath within 2±0.5		
1	seconds.			solder shall cover min	
1				mun 95% of the surface	
				being immersed.	
Vibration		condition by a frequency s	•	(1).Frequency	
	1	quency range from 10HZ t		Change:±5ppm	
		be transverseb in 1min. An	·	(2).Resistance:±15%	
	1	1.5mm this motion shall be			
 '		nutually perpendicular axes	· · · · · · · · · · · · · · · · · · ·		
Drop	Form /ucm	n height 3 times on 3cm har	d wooden floor	(1).Frequency	
i				Change:±5ppm	
De combant		The first of a tampa	· · · · · · · · · · · · · · · · · · ·	(2).Resistance:±15%	
Damp heat		•	erature of 40±2°C with relative	, , ,	
	_		en it shall be subjected to		
1		·	for 1 \sim 2h after which	n (2).Resistance:±15%	
Dry heat		ent shall be made.	erature of 100°C±5°C for 24h,	, (1).Frequency	
Diy ileat		nail be stored at a temper			
1		r which measurement shall		(2).Resistance:±15%	
Cold			ture of-40°C±5°C for 48h, then	` '	
00.4		·	spheric conditions $$ for 1 \sim 2 $^{ m c}$, , , ,	
		measurement shall be made	•	(2).Resistance:±15%	
Aging	+		ure of 85°C±5°C for 7d then it	· · ·	
7.133		· '	pheric conditions for $1\sim2h$	specification	
1		measurement shall be made			
Temperature			essive change of temperature	e Refer to verdict	
cycling		<u>-</u>	then it shall be subjected to		
	1 -	·	for 1 \sim 2h after which	· ·	
1		ent shall be made			
1		Temperature	Duration		
i	1	-40℃±3℃			
1	2	Standard atmospheric	Within 30s		
i		conditions			
1	3	100℃±3℃	30min		
1	4	Standard atmospheric	Within 30s		
		conditions			

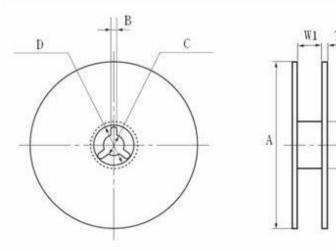


Test Item	Condition of test	Performal Requireme		
Sealing	The crystal filter unit shall be immersed in a industry alcohol for Insulation			
	5±0.5 minutes then 25±3℃ 1~2 Hr before testing	Resistance>5	500ΜΩ	
Resistance to		Refer to	verdict	
soldering heat	PEAK 10S MAX	specification		
	265 TO 200 TO 200 TO 150 TO 44 TO 90 S 60 TO 120 S 25 TO Peak : 360s TIME (Seconds) Total : 420S			
	Reflow soldering cure see the chart.			
	Soldering iron method:			
1	Bit temperature: 350 ℃ ±10 ℃			
	Application time of soldering iron:5s Max			



10. Packing Desrciption





	HC-49SMD	8045	7050	6035	5032	4025	3225
w	24.00 ± 0.30	16.00 ± 0.05	16.00 ± 0.05	12.00 ± 0.05	12.00 ± 0.05	12.00 ± 0.05	12.00 ± 0.05
E	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10
F	11.5 ± 0.10	7.5 ± 0.10	7.5 ± 0.10	5.5 ± 0.10	5.5 ± 0.10	5.5 ± 0.10	5.5 ± 0.10
T	0.40 ± 0.05	0.35 ± 0.05	0.35 ± 0.05	0.35 ± 0.05	0.35 ± 0.05	0.35 ± 0.05	0.30 ± 0.05
p	12.00 ± 0.10	8.00 ± 0.10	8.00 ± 0.10	8.00 ± 0.10	8.00 ± 0.10	8.00 ± 0.10	8.00 ± 0.10
P0	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10
P2	2.00 ± 0.10	2.00 ± 0.10	2.00 ± 0.10	2.00 ± 0.10	2.00 ± 0.10	2.00 ± 0.10	2.00 ± 0.10
D0	ф 1.50+0.10	ф 1.50+0.10	ф 1.50+0.10	ф 1.50+0.10	ф 1.50+0.10	ф 1.50+0.10	ф1.50+0.10
DI	ф 1.50 MIN	ф 1.50МПМ	ф 1.50 МIN	ф 1.50 МIN	ф 1.50 МП N	ф 1.50МПМ	ф1.50 MIN
A0	4.80±0.10	4.85 ± 0.10	5.40 ± 0.10	3.90 ± 0.10	3.60 ± 0.10	2.80 ± 0.10	2.85 ± 0.10
K0	4.40 ± 0.10	1.90 ± 0.10	1.80 ± 0.10	1.50 ± 0.10	1.10 ± 0.10	0.90 ± 0.10	0.85 ± 0.10
B0	14.20 ± 0.15	8.60 ± 0.15	7.40 ± 0.10	6.40 ± 0.10	5.40 ± 0.10	4.30 ± 0.10	3.55 ± 0.10
A	ф330 ± 1.0	φ 178 ± 2.0	ф 178 ± 2.0	ф 178 ± 2.0	ф 178 ± 2.0	ф 178 ± 2.0	Φ 178 ± 2.0
В	2.30 ± 0.20	2.00 ± 0.50	2.00 ± 0.50	2.00 ± 0.50	2.00 ± 0.50	2.00 ± 0.50	2.00 ± 0.50
С	φ 13.5 ± 0.20	Φ 13.2 ± 0.20	ф 13.2 ± 0.20	φ 13.2 ± 0.20	ф 13.2 ± 0.20	φ 13.2 ± 0.20	φ 13.2 ± 0.20
D	Φ21.5 ± 0.20	φ20.0 ± 0.50	ф20.0±0.50	Φ 20.0 ± 0.50	φ20.0 ± 0.50	φ20.0 ± 0.50	Φ20.0±0.50
N	ф 100.0 ± 0.5	φ60.5 ± 1.0	Φ60.5 ± 1.0	Φ60.5 ± 1.0	Φ60.5 ± 1.0	Φ60.5 ± 1.0	Φ60.5 ± 1.0
Wl	24.5 ± 0.20	16.5 ± 0.20	16.5 ± 0.20	12.5 ± 0.20	12.5 ± 0.20	12.5 ± 0.20	12.5 ± 0.20
T1	2.30 ± 0.20	1.80 ± 0.20	1.80 ± 0.20	1.80 ± 0.20	1.80 ± 0.20	1.80 ± 0.20	1.80 ± 0.20



